

# Polytec TC 432

## Properties

Polytec TC 432 is a thixotropic, two component, highly thermally conductive, electrically insulating epoxy for thermal management in micro and power electronics, energy engineering etc.

Polytec TC 432 has an excellent adhesion to ceramic, glass, semiconductor materials, ferrous and non-ferrous metals and most plastics

The material can be applied via dispensing, screen printing, or manual application.



## Processing

- For two-component products the components A and B should be mixed carefully within the specified mixing ratio.
- For filled products both components should be homogenized carefully prior mixing, in order to prevent a possible settling of the filler.
- Processing should be carried out rapidly after mixing the components; as an indication the pot life can be used.
- Surfaces should be clean, thus free of dirt, grease, oil, dust or process chemicals.
- One-component products can be applied directly and are not subject to a pot life (except pre-mixed/frozen products).
- Please take notice of respective minimum curing temperature and time.
- For Safety information please refer to the respective Material Safety Data Sheet.

# Polytec TC 432

## Thermally Conductive Adhesive

### Technical Data

# Polytec TC 432

Properties in uncured state	Method	Unit	Technical Data
Chemical basis	-	-	Epoxy
No. of components	-	-	2
Mixing ratio (weight)	-	-	100:7
Mixing ratio (volume)	-	-	-
Pot life at 23°C	TM 702	Minutes	15
Storage Stability at 23°C	TM 701	Months	12
Consistency	TM 101	-	Thixotropic paste
Density Mix	TM 201.2	g/cm <sup>3</sup>	1.5
Density A-Part	TM 201.2	g/cm <sup>3</sup>	1.58
Density B-Part	TM 201.2	g/cm <sup>3</sup>	0.98
Type of filler	-	-	Boron nitride
Max. particle size	-	µm	140
Viscosity Mix 10 s <sup>-1</sup> at 23°C	TM 202.11	mPa·s	65 000
Viscosity A-Part 84 s <sup>-1</sup> at 23°C	TM 202	mPa·s	-
Viscosity B-Part 84 s <sup>-1</sup> at 23°C	TM 202	mPa·s	-

Properties in cured* state	Method	Unit	Technical Data
Colour (before / after curing)	TM 101	-	White / white
Hardness (Shore D)	DIN EN ISO 868	-	>65
Temperature resistance continuous	TM 302	°C	-55 / +180
Temperature resistance short term	TM 302	°C	-55 / +230
Degradation Temperature	TM 302	°C	+350
Glass Transition Temperature (T <sub>g</sub> )	TM 501	°C	-
Coefficient of thermal expansion (<T <sub>g</sub> )	ISO 11359-2	ppm	-
Coefficient of thermal expansion (>T <sub>g</sub> )	ISO 11359-2	ppm	-
Thermal conductivity	TM 502	W/m·K	1.8 ±0.2
Specific volume resistivity	DIN EN ISO 3915	Ω·cm	-
Young modulus	TM 605	N/mm <sup>2</sup>	10 000
Tensile strength	TM 605	N/mm <sup>2</sup>	36
Lap shear strength (Al/Al)	TM 604	N/mm <sup>2</sup>	9
Elongation at break	TM 605	%	0.4
Water absorption 24 h, 23°C	TM 301	%	-

\*The above data has been determined with samples cured at 23 °C. Please notice, by varying the curing temperature these properties can be influenced to some extent.

# Polytec TC 432

Curing*	Method	Unit	Technical Data
Minimum curing temperature		°C	15
Curing time at 23°C		h	24
Curing time at 150°C		min	-
Curing time at 180°C		s	-

\*Curing temperatures refer to the temperature in the respective bond line. When choosing the respective curing conditions, the time needed to heat the substrate has to be considered. Depending on the type of heat source (convection oven, hot stamp, heating plate) the heat input may vary.

## Standard pack sizes:

250 g, 500 g

1 kg

## Customized Packaging

### Please note:

The above listed information are typical data based on tests and are believed to be accurate. Polytec PT makes no warranties (expressed or implied) as to their accuracy. The above listed data do not constitute specifications. The processing (in particular the cure conditions) of the material, the process control and the variety of different applications at various customers are not under Polytec PT's control. Therefore Polytec PT will not be liable for concrete results in any specific application or in any connection with the use of this product. In particular the cure conditions do have a major effect on the properties of the cured material. Therefore it is highly recommended to keep the cure schedule – once established - under tight control. With the release of this data sheet all former data sheets will be null and void.

Subject to alteration.

Polytec PT GmbH  
Polymere Technologien  
Ettlinger Straße 30  
76307 Karlsbad  
Germany  
Tel. +49 (0) 7243 604-4000  
Fax +49 (0) 7243 604-4200  
info@polytec-pt.de  
<http://www.polytec-pt.de>

Polytec France S.A.S.  
TECHNOSUD II  
Bâtiment A  
99, Rue Pierre Semard  
92320 Châtillon - France  
Phone. +33 (0)1 49 65 69 00  
Fax +33 (0)1 57 19 59 60  
info@polytec.fr  
<http://www.polytec-pt.com>

Polytec South-East Asia Pte Ltd  
Blk 4010 Ang Mo Kio Ave 10  
#06-06 Techplace I  
Singapore 569626  
Tel. +65 6451 0886  
Fax +65 6451 0822  
info@polytec-sea.com  
<http://www.polytec-pt.com>